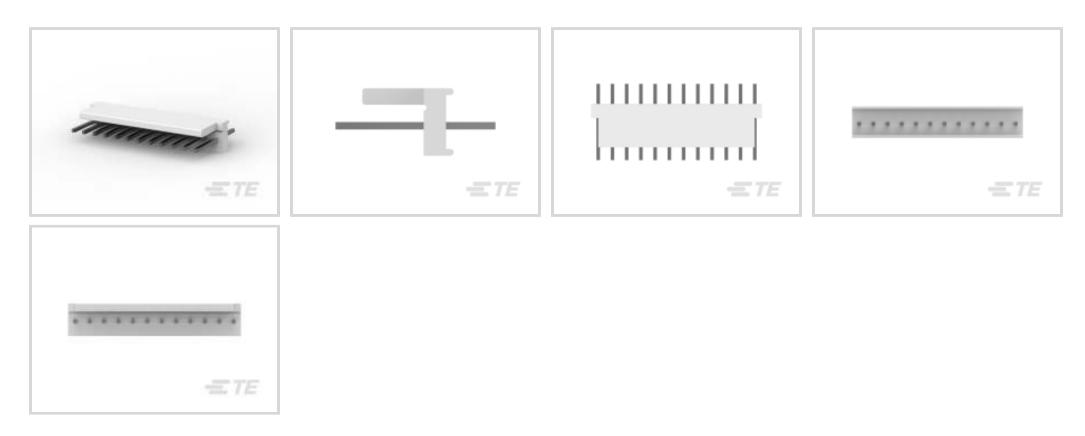
1-640454-2 - ACTIVE

MTA 100

TE Internal #: 1-640454-2 PCB Mount Header, Vertical, Wire-to-Board, 12 Position, 2.54 mm [. 1 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, Signal, MTA 100

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles > PCB Header: Polyester, Vertical, 2.54 mm



Connector System: Wire-to-Board

Number of Positions: 12

Number of Rows: 1

Centerline (Pitch): 2.54 mm [.1 in]

PCB Mount Orientation: Vertical

All PCB Header: Polyester, Vertical, 2.54 mm (31)

connectivity

Features

Product Type Features

Connector System	Wire-to-Board
Header Type	Partially Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
PCB Connector Assembly Type	PCB Mount Header
Configuration Features	
Number of Positions	12
Number of Rows	1
PCB Mount Orientation	Vertical
Electrical Characteristics	
Operating Voltage	250 VAC
Body Features	

PCB Mount Header, Vertical, Wire-to-Board, 12 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, Signal, MTA 100



Primary Product Color	Natural
Contact Features	
Contact Mating Area Length	7.49 mm[.295 in]
Mating Square Post Dimension	.64 mm[.025 in]
PCB Contact Termination Area Plating Material Thickness	3.81 μm[150 μin]
Contact Layout	Inline
Contact Underplating Material Thickness	1.27 μm[50 μin]
Contact Mating Area Plating Material Thickness	3.81 μm[150 μin]
Contact Shape & Form	Square
Contact Mating Area Plating Material Finish	Matte
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Copper Alloy
Contact Mating Area Plating Material	Tin
Contact Type	Pin
Contact Current Rating (Max)	5 A

Termination Features

Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Post & Tail Length	3.56 mm[.14 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Alignment Type	Polarization
Mating Retention	Without
Panel Mount Feature	Without
Connector Mounting Type	Board Mount
Mating Alignment	With
PCB Mount Alignment	Without
PCB Mount Retention	Without
Housing Features	
Housing Material	Polyester - GF
Centerline (Pitch)	2.54 mm[.1 in]
Dimensions	

C For support call+1 800 522 6752

PCB Mount Header, Vertical, Wire-to-Board, 12 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, Signal, MTA 100



Connector Length	33.02 mm[1.3 in]	
Connector Height	7.75 mm[.305 in]	
PCB Thickness (Recommended)	1.6 mm[.063 in]	
Usage Conditions		
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]	
Operation/Application		
Circuit Application	Signal	
Industry Standards		
Agency/Standard	CSA, UL	
Approved Standards	CSA LR7189, UL E28476	
UL Flammability Rating	UL 94V-0	
Packaging Features		
Packaging Quantity	1	
Packaging Type	Package	

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant	
EU ELV Directive 2000/53/EC	Compliant	
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold	
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JAN 2023 (233) Does not contain REACH SVHC	
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.	
Solder Process Capability	Wave solder capable to 265°C	

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides

PCB Mount Header, Vertical, Wire-to-Board, 12 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, Signal, MTA 100



on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

Compatible Parts





Also in the Series MTA 100

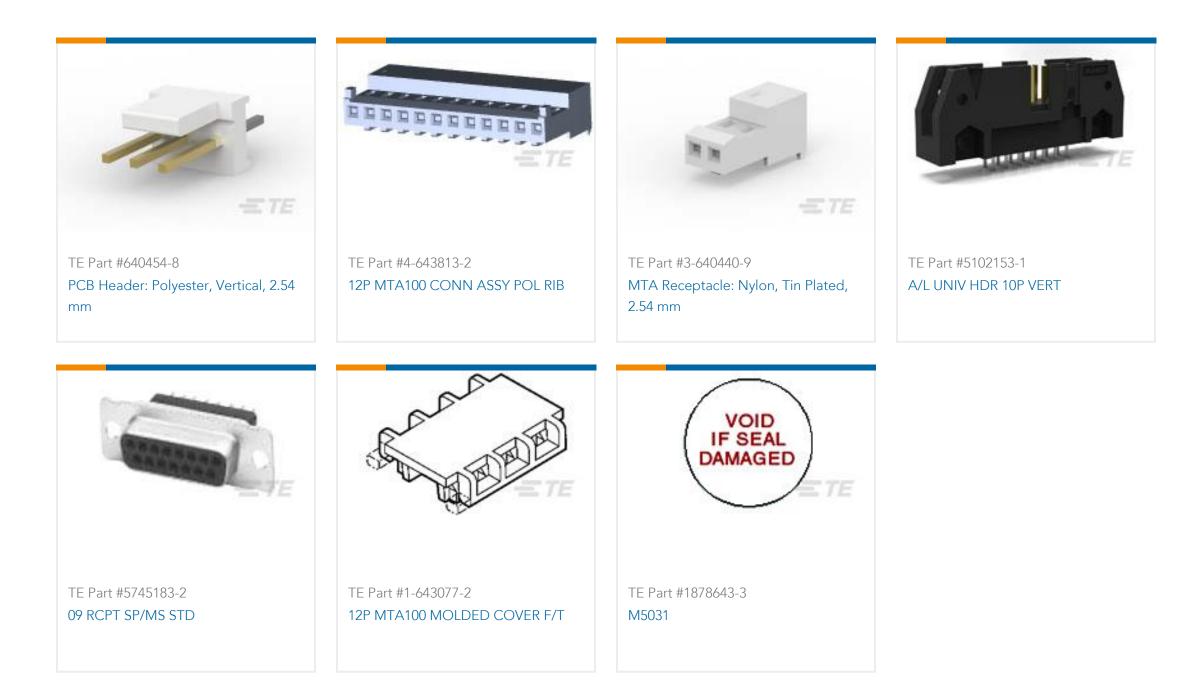


Insertion & Extraction Tools(2)	PCB Connector Covers(69)	PCB Connector Keying(1)	PCB Headers & Receptacles(451)
		A AN AN	
Standard Rectangular Connectors(497)	Wire-to-Board Connector Assemblies & Housings(1)	Wire-to-Board Connector Contacts(8)	

Customers Also Bought

PCB Mount Header, Vertical, Wire-to-Board, 12 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, Signal, MTA 100





Documents

Product Drawings 12P MTA100 HDR ASSY SQ STR POL

English

CAD Files

Customer View Model ENG_CVM_CVM_1-640454-2_AA.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1-640454-2_AA.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1-640454-2_AA.3d_stp.zip

English

By downloading the CAD file I accept and agree to the Terms and Conditions of use

Product Specifications Application Specification

English

Product Environmental Compliance Product Compliance

English

Product Compliance

English

PCB Mount Header, Vertical, Wire-to-Board, 12 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, Signal, MTA 100



Agency Approvals Agency Approval Document

English